ASSIGNMENT RECORDATION ***	03-28-2		ents Only		
To the Honorable Commissioner of Pater				Date: March 19, 2002 Attorney Docket No. 5649-942	
Please record the attached original docun	1020351	08	- Thomas Booker		
1. Name of conveying party(ies):		2. Name and a	ddress of receiving party(ies):		
Eun-ae Chung Doo-sup Hwang Cha-young Yoo 3 - 19	.02	416 Maetan	lectronics Co., Ltd. I-dong, Paldal-gu r, Kyungki-do Korea	1046 U.S. PTO 10/101353	
Additional name(s) of conveying party(ies) attached?	Yes No				
3. Nature of conveyance:					
X Assignment Merger Security Agreement Change of Name Other Execution Date: March 11, 2002		Additional name(s) & address(es) attached" Yes _	No	
4. Application Serial NoPa	itent No.	0,10135	3		
If this document is being filed together with a is: March 11, 2002	a new application, the	e execution date	of the application		
Additional numbers attached?Yes	No				
5. Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involved: 1			
		7. Total fee (37 CFR 3.41) \$40.00			
David K. Purks Myers Bigel Sibley & Sajovec P. O. Box 37428		Enclos			
Raleigh NC 27627		8. Deposit account number: 50-0220			
DO NOT USE THIS SPACE					
9. Statement and signature To the best of my knowledge and belief, the f of the original document.	foregoing information	is true and cor	rect and any attached copy is	a true copy	
David K. Purks #40,133 Name of Person Signing Total number of pages including cover sheet, at	Signature ttachments and docur		rch 19, 2002 Date		

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> **PATENT REEL: 012715 FRAME: 0084**

ASSIGNMENT

THIS ASSIGNMENT, made by us, **Eun-ae Chung**, citizen of the Republic of Korea, residing at 16-1108, Suwon P.O. BOX 125, Janan-gu, Suwon-city, Kyungki-do, Republic of Korea; **Doo-sup Hwang**, citizen of the Republic of Korea, residing at 205-904, Samsung 2-cha Apt., 692-1, Poongduckcheon-ri, Suji-eub, Yongin-city, Kyungki-do, Republic of Korea; and **Cha-young Yoo**, citizen of the Republic of Korea, residing at 203-1302, LG Village, 530, Keumgok-dong, Kwonsun-gu, Suwon-city, Kyungki-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in METHOD FOR MANUFACTURING A SEMICONDUCTOR DEVICE WHEREBY DEGRADATION OF SURFACE MORPHOLOGY OF A METAL LAYER FROM THERMAL OXIDATION IS SUPPRESSED for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. ________, filed _______) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-City, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as

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fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to bind our heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

Eun-ne Chi	ing
Eun-ae Chung	
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Doo-sup Hwar	ıg V
Cha-young Yo	Y00
Cha-young Yo	0

Witnesse	ed by:		
Date:		 <u> </u>	
Date:		 	

RECORDED: 03/19/2002